

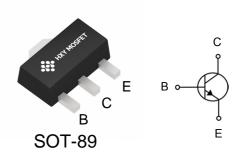
#### **Features**

Collector Current: I<sub>C</sub>= 2A

• Power Dissipation of 500mW

### **Package Marking and Ordering Information**

Product ID	) Pack Marking		Qty(PCS)	
2SD1624	SOT-89	DG	1000	



### Maximum Ratings (Ta=25 unless otherwise noted)

Symbl	Parameter	Value	Unit
Vсво	Collector-Base Voltage	60	V
VCEO	Collector-Emitter Voltage	50	V
VEBO	Emitter-Base Voltage	6	V
Ic	Collector Current-Continuous	3	Α
I <sub>CP</sub>	Collector Current -Pulsed	6	Α
Pc	Collector Power Dissipation	500	mW
T <sub>j</sub>	Junction Temperature	150	$^{\circ}$
T <sub>stg</sub>	Storage Temperature	-55-150	$^{\circ}$

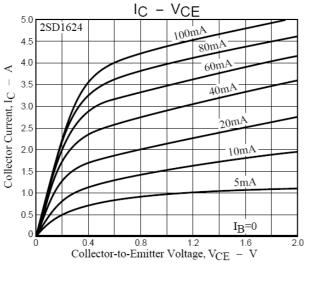
## Electrical Characteristics (Ta=25 unless otherwise specified)

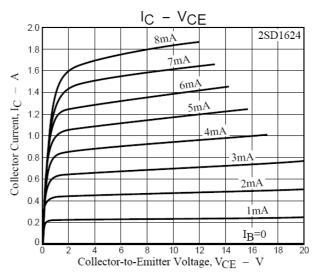
Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_{C}=50\mu A, I_{E}=0$	60			<b>V</b>
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> =1mA,I <sub>B</sub> =0	50			<b>V</b>
Emitter-base breakdown voltage	$V_{(BR)EBO}$	I <sub>E</sub> =50μA,I <sub>C</sub> =0	6			V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> =40 ¼ <sub>E</sub> =0			0.1	μΑ
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> =4V,I <sub>C</sub> =0			0.1	μΑ
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> =2V, I <sub>C</sub> =100mA	100		560	
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> =2V, I <sub>C</sub> =3A	35		560	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> =2A,I <sub>B</sub> =100mA		0.35	0.7	<b>V</b>
Base-emitter saturation voltage	V <sub>EB(sat)</sub>	I <sub>C</sub> =2A,I <sub>B</sub> =100mA		0.94	1.2	V
Transition frequency	f⊤	VcE=10V,Ic=50mA		150		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB}$ =10V, $I_{E}$ =0, f=1MHz		39		pF

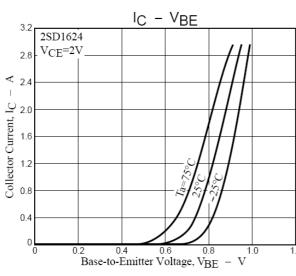
### Classifiction Of hFE

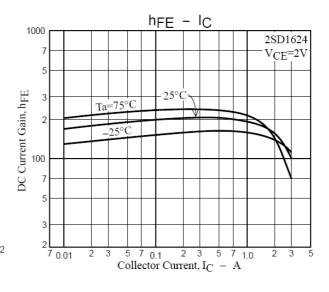
Rank	R	S	Т	U
Range	100-200	140-280	200-400	280-560

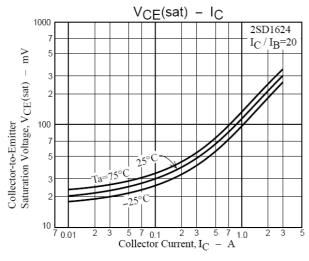
### **Typical Characteristics**

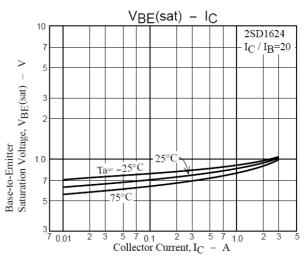




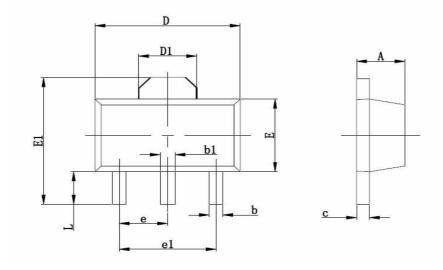








# **SOT-89 Package Outline Dimensions**



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min	Max	Min	Max	
Α	1.400	1.600	0.055	0.063	
b	0.320	0.520	0.013	0.020	
b1	0.400	0.580	0.016	0.023	
С	0.350	0.440	0.014	0.017	
D	4.400	4.600	0.173	0.181	
D1	1.550 REF.		0.061 REF.		
E	2.300	2.600	0.091	0.102	
E1	3.940	4.250	0.155	0.167	
е	1.500 TYP.		0.060 TYP.		
e1	3.000 TYP.		0.118 TYP.		
L	0.900	1.200	0.035	0.047	



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